

STW75NF30

N-channel 300 V, 35 mΩ typ., 60 A STripFET™ II Power MOSFET in a TO-247 package

Datasheet - production data



Order code	VDS	RDS(on) max.	ID	Ртот
STW75NF30	300 V	45 mΩ	60 A	320 W

- Exceptional dv/dt capability
- 100% avalanche tested
- Low gate charge

Applications

• Switching applications

Description

This Power MOSFET series realized with STMicroelectronics unique STripFET™ process is specifically designed to minimize input capacitance and gate charge. It is therefore ideal as a primary switch in advanced high-efficiency isolated DC-DC converters.

Figure 1: Internal schematic diagram

TO-247

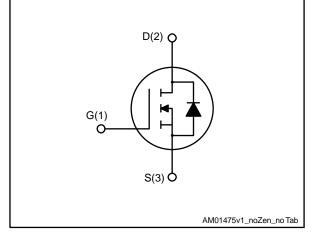


Table 1: Device summary

Order code	Marking	Package	Packing
STW75NF30	75NF30	TO-247	Tube

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
Vds	Drain-source voltage	300	V	
V _{GS}	Gate-source voltage	±20	V	
lo	Drain current (continuous) at $T_C = 25 \ ^{\circ}C$	60	А	
lo	Drain current (continuous) at Tc= 100 °C	37.8	А	
IDM ⁽¹⁾	Drain current (pulsed)	240	А	
Ртот	Total dissipation at $T_c = 25 \ ^{\circ}C$	320	W	
dv/dt ⁽²⁾	Peak diode recovery voltage slope	12	V/ns	
T _{stg}	Storage temperature range			
Tj	Operating junction temperature range	- 55 to 150	°C	

Notes:

 $\ensuremath{^{(1)}}\ensuremath{\mathsf{Pulse}}$ width limited by safe operating area.

 $^{(2)}$ I_{SD} \leq 60 A, di/dt \leq 200 A/µs; V_{DD} \leq 80% V(_BR)DSS

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj} -case	Thermal resistance junction-case	0.39	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	50	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
lar	Avalanche current, repetitive or non- repetitive (pulse width limited by T _{jmax} .)	50	А
Eas	Single pulse avalanche energy (starting T_j = 25 °C, I_D = I_{AR} , V_{DD} = 50 V)	400	mJ



2 Electrical characteristics

(Tc= 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 V, I_D = 1 mA$	300			V
		$V_{GS} = 0 V, V_{DS} = 300 V$			1	μA
	Zero-gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 300 \text{ V},$ $T_{C} = 125 \text{ °C} (1)$			10	μA
I _{GSS}	Gate-body leakage current	V_{DS} = 0 V, V_{GS} = ±25 V			±100	nA
V _{GS(th)}	Gate threshold voltage	V_{DS} = V_{GS} , I_D = 250 μ A	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		35	45	mΩ

Notes:

⁽¹⁾Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	5930	-	pF
Coss	Output capacitance	$V_{DS} = 25 V, f = 1 MHz,$	-	837	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0 V$	-	110	-	pF
Coss eq. ⁽¹⁾	Equivalent output capacitance	$V_{DS} = 0 V$ to 240 V, $V_{GS} = 0 V$	-	462	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I _D =0 A	-	1.55	-	Ω
Qg	Total gate charge	$V_{DD} = 240 \text{ V}, I_D = 60 \text{ A}, V_{GS} = 0$	-	164	-	nC
Qgs	Gate-source charge	to 10 V (see Figure 15: "Test circuit for gate charge	-	36	-	nC
Q _{gd}	Gate-drain charge	behavior")	-	69	-	nC

Table 6: Dynamic

Notes:

 $^{(1)}C_{\text{oss eq.}}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

Т	able 7:	Switching	times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 150 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	I	115	-	ns
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 14: "Test circuit for	-	87	-	ns
t _{d(off)}	Turn-off-delay time	resistive load switching times"	-	141	-	ns
t _f	Fall time	and Figure 19: "Switching time waveform")	-	101	-	ns



Electrical characteristics

Table 8: Source-drain diode							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
Isd	Source-drain current		-		60	А	
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		240	А	
Vsd ⁽²⁾	Forward on voltage	V _{GS} = 0 V, I _{SD} = 60 A	-		1.6	V	
trr	Reverse recovery time	I _{SD} = 60 A, di/dt = 100 A/µs,	-	252		ns	
Qrr	Reverse recovery charge	V _{DD} = 60 V (see Figure 16: "Test circuit for inductive load	-	2.5		μC	
I _{RRM}	Reverse recovery current	switching and diode recovery times")	-	20		A	
trr	Reverse recovery time	I _{SD} = 60 A, di/dt = 100 A/µs,	-	316		ns	
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{\text{j}} = 150 \text{ °C}$ (see Figure 16: "Test circuit for	-	3.7		μC	
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	23.2		A	

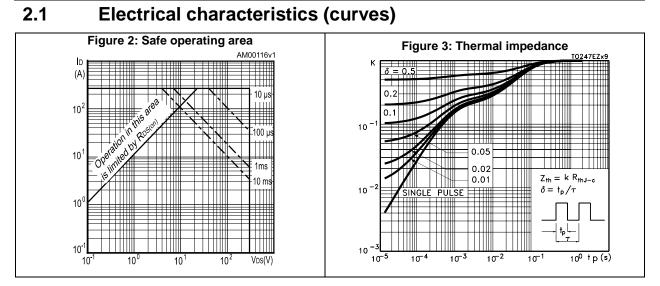
Notes:

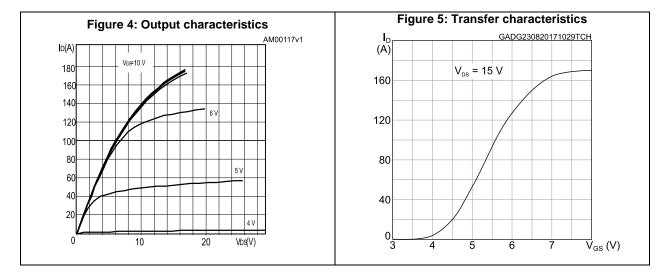
 $\ensuremath{^{(1)}}\ensuremath{\mathsf{Pulse}}$ width is limited by safe operating area.

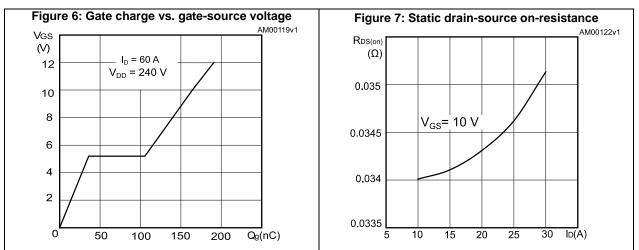
 $^{(2)}\text{Pulse test: pulse duration}$ = 300 $\mu\text{s},$ duty cycle 1.5%.



Electrical characteristics







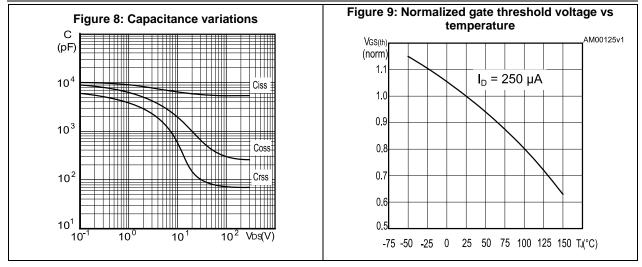
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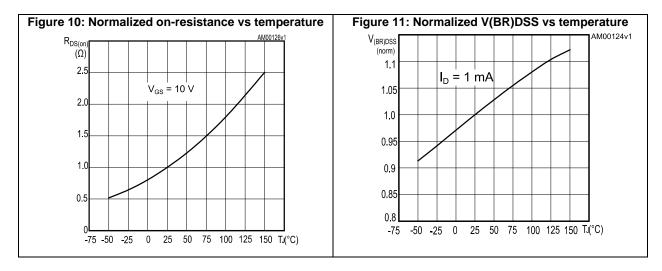


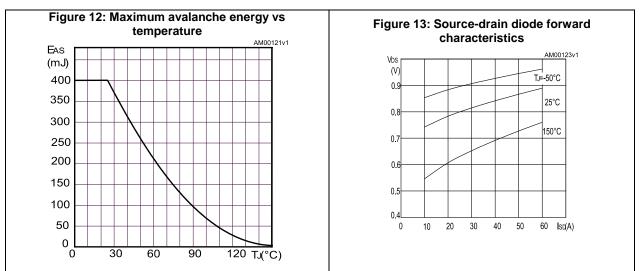
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Electrical characteristics

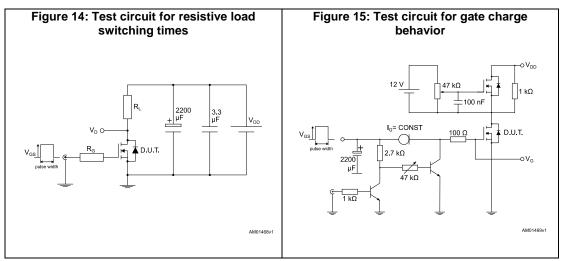


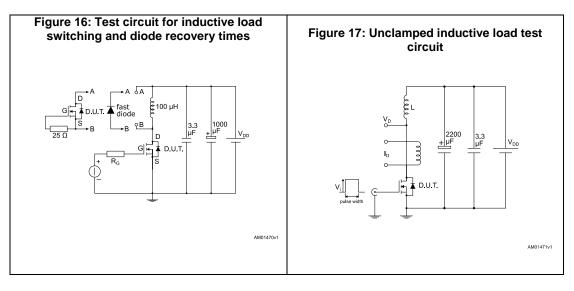


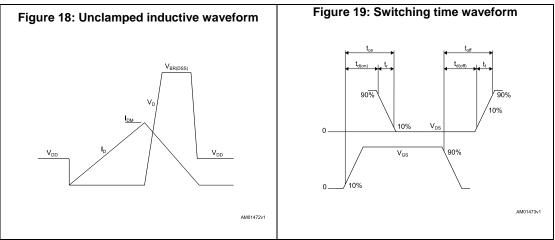


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3 Test circuits







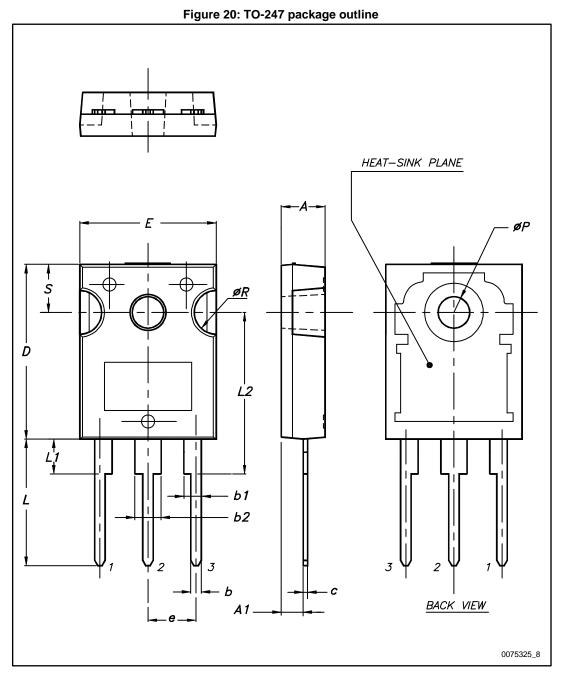


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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-247 package information



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Package mechanical data

Table 9: TO-247 package mechanical data

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Dim.		mm			
Dini.	Min.	Тур.	Max.		
A	4.85		5.15		
A1	2.20		2.60		
b	1.0		1.40		
b1	2.0		2.40		
b2	3.0		3.40		
С	0.40		0.80		
D	19.85		20.15		
E	15.45		15.75		
е	5.30	5.45	5.60		
L	14.20		14.80		
L1	3.70		4.30		
L2		18.50			
ØP	3.55		3.65		
ØR	4.50		5.50		
S	5.30	5.50	5.70		



5 Revision history

Table 10: Document revision history

Date	Revision	Changes
23-Oct-2007	1	First release.
27-May-2008	2	New value inserted in Table 6: Dynamic
15-Jul-2008	3	Document status promoted from preliminary data to datasheet.
24-Aug-2017	4	Updated Section 2.1: "Electrical characteristics (curves)" and Section 4.1: "TO-247 package information".



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